

# Chip Bead For GHz noise suppression

## CIV05 Series (1005/ EIA 0402)

## APPLICATION

High frequency EMI prevention application to computers, printers, VCRs, TVs and mobile phones.

#### FEATURES

- CIV Series have high impedance in a GHz band and suppress GHz noise which is usually made due to high frequency of the electronic appliances, high speed and mass storage of the data.
- Excellent solderability and high heat resistance for either flow or reflow soldering
- Monolithic inorganic material construction for high reliability



#### **RECOMMENDED LAND PATTERN**



#### DIMENSION



Туре	Dimension [mm]				
	L	W	t	d	
05	1.0±0.05	0.5±0.05	0.5±0.05	0.25±0.1	

#### DESCRIPTION

Part no.	Impedance	Impedance	DC Resistance	Rated Current
	(Ω) <b>±25%@100MHz</b>	(Ω) <b>±40%@1GHz</b>	(Ω) Max.	(mA) Max.
CIV05U601	600	1000	0.7	300
CIV05U102	1000	1400	1.1	250
CIV05J102	1000	2000	1.25	250
CIV05J182	1800	2700	2.20	200





## PRODUCT IDENTIFICATION



- (1) Chip Beads
- (3) Dimension
- (5) Nominal impedance (601:600Ω, 102:1000Ω)
- (6) Thickness option(N:Standard, A:Thinner than standard, B:Thicker than standard)
- (7) Packaging(C:paper tape, E:embossed tape)
- (2) Multi-layer type for GHz Noies suppression
- (4) Material Code



Ver 201306

### **REFLOW SOLDERING**

FLOW SOLDERING



PACKAGING

Packaging Style	Quantity(pcs/reel)
Card Board Taping	4000

Any data in this sheet are subject to change, modify or discontinue without notice. The data sheets include the typical data for design reference only. If there is any question regarding the data sheets, please contact our sales personnel or application engineers.